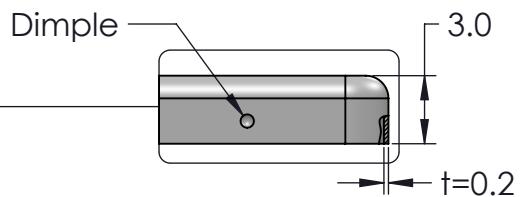
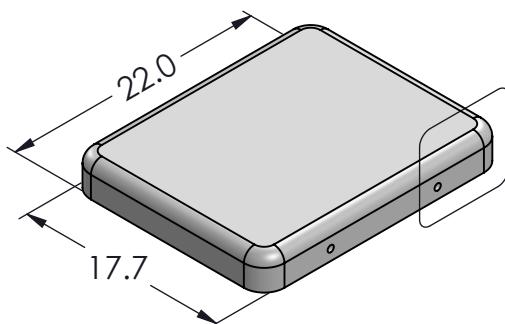


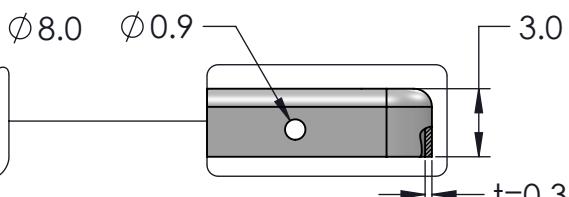
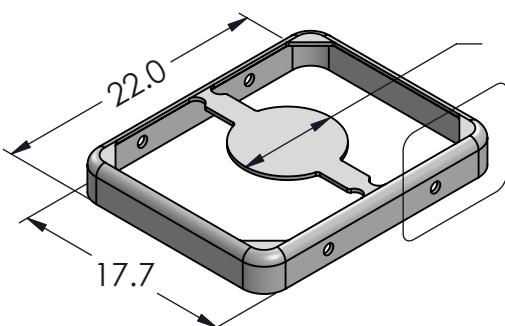
Cover
MS220-20C

(internal)



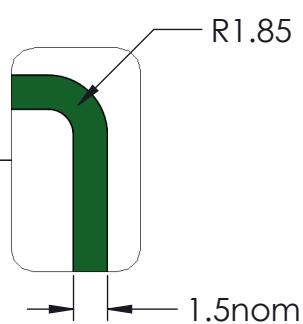
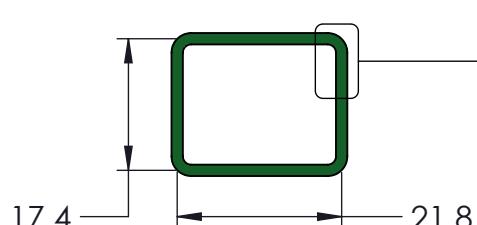
Frame
MS220-20F

(external)



Foot Print (1:1)

(symmetry)



Board Level Shielding
Design & fabrication

Item No:	Description:	Material:
MS220-20	DRAWN RF SHEILD FRAME + COVER	TIN STEEL (See Note 1-2)

Note: (1) TS275E 8.4/8.4 (2) Electrolytic Tin Plate As Per EN 10202:2001 Min Tin Thickness 3.5 μ m
(3) General tolerance ± 0.2 mm Non Dimensioned items remain **Masach Technologies LTD** property.



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MMGS / Print 1:1 / A4